CMOS Digital Integrated Circuits Silicon Monolithic

# TCUA231WBG

#### 1. Functional Description

· USB 2.0 High-Speed, UART, and Audio Switch with Negative Signal Capability

#### 2. General

The TCUA231WBG is a dual SP3T switch for combined  $USB\ 2.0$  High-Speed , audio and UART signals.

The audio switch is designed to allow audio signals to swing below ground.

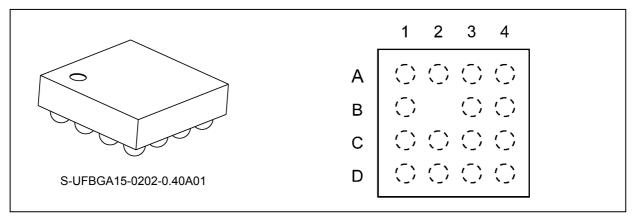
When  $V_{BUS}$  is High, the USB switches (D+ and D-) are selected, regardless of the logic levels of the Head and Man inputs. When  $V_{BUS}$  is Low or left open and Head is Low, the Audio switches (R and L) are selected. When  $V_{BUS}$  is Low or left open, Head is High and Man is Low, the UART switches (TX and RX) are selected.

All the inputs are protected against electrostatic discharge.

#### 3. Features

- (1) Supply voltage:  $V_{CC} = 2.3 \text{ to } 3.6 \text{ V}$
- (2) Switch terminal ON-capacitance (D+, D-):  $C_{\text{L/O}} = 8 \text{ pF}$  Switch ON (typ.) @ $V_{\text{CC}} = 3.3 \text{ V}$
- (3) ON-resistance (D+, D-):  $R_{ON} = 6.5 \Omega$  (typ.) @ $V_{CC} = 3 V$ ,  $V_{IS} = 0 V$
- (4) ON-resistance (R, L):  $R_{ON} = 5.5 \Omega$  (typ.) @ $V_{CC} = 3 V$ ,  $V_{IS} = 0 V$
- (5) ON-resistance flatness (R, L):  $R_{ON(flat)} = 2 \Omega$  (typ.) @ $V_{CC} = 3 V$
- (6) ESD performance: Machine model  $\geq \pm 200 \text{ V}$ , Human body model  $\geq \pm 2000 \text{ V}$
- (7) Package: WCSP15 (1.6 mm × 1.6 mm)

## 4. Packaging and Pin Assignment (Top View)



### 4.1. Pin Assignment

	1	2	3	4
Α	COM+	XSTDT	R	L
В	COM-	No Ball	$V_{CC}$	D+
С	$V_{BUS}$	GND	GND	D-
D	Head	Man	TX	RX



## 5. Marking

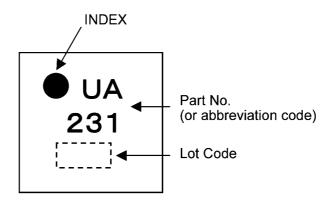


Fig. 5.1 Marking

## 6. Block Diagram

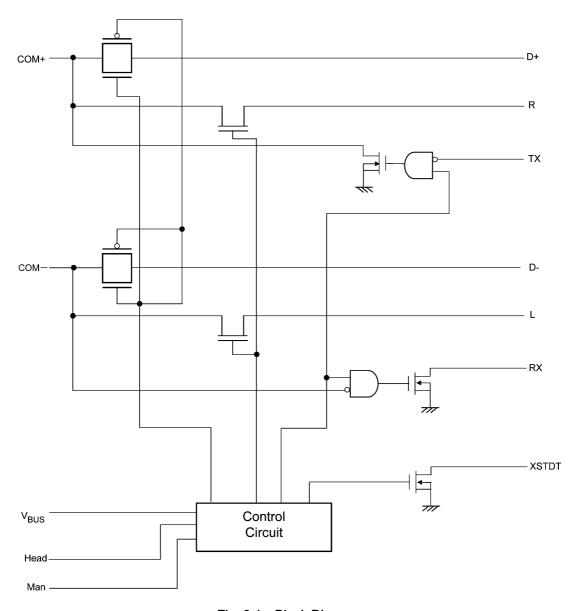


Fig. 6.1 Block Diagram



### 7. Principle of Operation

#### 7.1. Truth Table

Input Head	Input Man	Input V <sub>BUS</sub>	Output XSTDT	Switch D+/D-	Switch R/L	Switch TX/RX
L or H	L or H	5 V	Z	ON	OFF	Z
L	L or H	L	L	OFF	ON	Z
L	L or H	Open	Z	OFF	ON	Z
Н	L	L or Open	Z	OFF	OFF	ON
Н	Н	L or Open	Z	OFF	OFF	Z

## 8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Pin Name	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>			_	-0.5 to 4.6	V
Input voltage	V <sub>IN</sub>	Head, Man		_	-0.5 to 4.6	
		V <sub>BUS</sub>			-0.5 to 6.0	
Switch I/O voltage	Vs	D+, D-		Switch ON	-0.5 to V <sub>CC</sub> +0.5	
		R, L		Switch ON $-0.5 \le V_{CC} - V_S \le 6$	-2.0 to V <sub>CC</sub> +0.5	
		TX, RX		Switch ON	-0.5 to V <sub>CC</sub> +0.5	
		COM+, COM-		Switch ON $-0.5 \le V_{CC} - V_S \le 6$	-2.0 to V <sub>CC</sub> +0.5	
Switch I/O voltage	Vs	D+, D-		Switch OFF or	-0.5 to 4.6	
		R, L		V <sub>CC</sub> = 0 V	-0.5 to 4.6	
		TX, RX			-0.5 to 4.6	
		COM+, COM-			-2.0 to 4.0	
Switch I/O current	I <sub>S</sub>			_	50	mA
Power dissipation	P <sub>D</sub>			_	180	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>				±100	mA
Storage temperature	T <sub>stg</sub>			_	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



## 9. Operating Ranges (Note)

Characteristics	Symbol	Pin Name	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>			_	2.3 to 3.6	V
Input voltage	V <sub>IN</sub>	Head, Man		_	0 to 3.6	
		V <sub>BUS</sub>			0 to 5.5	
Switch I/O voltage	Vs	D+, D-		Switch ON	0 to V <sub>CC</sub>	
		R, L			-1.5 to V <sub>CC</sub>	
		TX, RX			0 to V <sub>CC</sub>	
		COM+, COM-			-1.5 to V <sub>CC</sub>	
Switch I/O voltage	Vs	D+, D-		Switch OFF or	0 to 3.6	
		R, L		V <sub>CC</sub> = 0 V	0 to 3.6	
		TX, RX			0 to 3.6	
		COM+, COM-			-1.5 to 3.6	
Operating temperature	T <sub>opr</sub>			_	-40 to 85	°C
Input rise time	dt/dv			_	0 to 10	ns/V
Input fall time					0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either  $V_{\text{CC}}$  or GND.



## 10. Electrical Characteristics

# 10.1. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Pin Name	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	V <sub>BUS</sub>		_	2.3 to 3.6	V <sub>CC</sub> + 0.6	_	_	V
Low-level input voltage	V <sub>IL</sub>	$V_{BUS}$		_	2.3 to 3.6			V <sub>CC</sub> - 0.5	
High-level input voltage	V <sub>IH</sub>	Head, Man		_	2.3 to 2.5	$0.50 \times V_{CC}$	_	_	
					2.7 to 3.0	0.45 ×V <sub>CC</sub>		_	
					3.3 to 3.6	0.40 ×V <sub>CC</sub>		_	
Low-level input voltage	V <sub>IL</sub>	Head, Man		_	2.3 to 3.6		l	0.15 ×V <sub>CC</sub>	
High-level input voltage	V <sub>IH</sub>	COM-, TX		Head = V <sub>CC</sub> , Man = 0 V	2.3 to 2.5	0.70 ×V <sub>CC</sub>	1	_	
					2.7 to 3.0	0.65 ×V <sub>CC</sub>	I	_	
					3.3 to 3.6	0.60 ×V <sub>CC</sub>	_	_	
Low-level input voltage	V <sub>IL</sub>	COM-, TX		Head = V <sub>CC</sub> , Man = 0 V	2.3 to 3.6			0.20 ×V <sub>CC</sub>	
Input leakage current	I <sub>IN</sub>	$V_{BUS}$		V <sub>IN</sub> = 0 to 5.5 V	2.3 to 3.6		_	±10	μΑ
		Head, Man		V <sub>IN</sub> = 0 to 3.6 V	2.3 to 3.6			±1	
Power-OFF leakage current	I <sub>OFF</sub>	D+, D-, R, L, TX, RX		V <sub>IS</sub> = 0 to 3.6 V	0		_	±10	
		COM+, COM-		V <sub>IS</sub> = -1.5 to 3.6 V	0	_	_	±10	
Switch OFF-state leakage current	I <sub>SZ</sub>	D+, D-, R, L, TX, RX		V <sub>IS</sub> = 0 V to V <sub>CC</sub> , Switch OFF	2.3 to 3.6	_	_	±10	
		COM+, COM-		$V_{IS}$ = -1.5 V to $V_{CC}$ , switch OFF	2.3 to 3.6	_	_	±10	
ON-resistance	R <sub>ON</sub>	D+, D-	(Note 1)	V <sub>BUS</sub> = 4.25 V, V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 30 mA	3.0	_	6.5	10	Ω
				V <sub>BUS</sub> = 4.25 V, V <sub>IS</sub> = 1.0 V, I <sub>IS</sub> = 30 mA	3.0	_	7.5	12	
				V <sub>BUS</sub> = 4.25 V, V <sub>IS</sub> = 3.0 V, I <sub>IS</sub> = 30 mA	3.0	_	22	40	
		R, L		V <sub>IS</sub> = -1.0 V, I <sub>IS</sub> = 30 mA	3.0	_	5.0	8	
				$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA}$	3.0		5.5	9	1
				$V_{IS} = 1.0 \text{ V}, I_{IS} = 30 \text{ mA}$	3.0		7.0	11	
ON-resistance flatness	R <sub>ON(flat)</sub>	R, L	(Note 1)	$V_{IS}$ = -1.0 to 1.0 V, $I_{IS}$ = 30 mA	3.0	_	2.0	_	
Low-level output voltage	V <sub>OL</sub>	COM+, RX		Head = $V_{CC}$ , Man = 0 V, $I_{OL}$ = 50 $\mu$ A	3.0		_	0.1	V
				Head = $V_{CC}$ , Man = 0 V, $I_{OL}$ = 4 mA	3.0	_	_	0.44	
		XSTDT		Head = 0 V, $V_{BUS}$ = 0 V, $I_{OL}$ = 50 $\mu A$	3.0	_	_	0.1	
				Head = 0 V, V <sub>BUS</sub> = 0 V, I <sub>OL</sub> = 1 mA	3.0	_	_	0.44	
Quiescent supply current	I <sub>CC</sub>			$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	3.6	_	_	2	μА
	Δl <sub>CC</sub>			V <sub>IN</sub> = 1.8 V (one input)	3.6	_		40	
					2.7		_	10	1

Note 1: All typical values are at  $T_a = 25$ °C.

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## 10.2. AC Characteristics (Unless otherwise specified, Ta = -40 to 85°C)

Characteristics	Symbol	Pin Name	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation delay time	t <sub>PLH</sub> /t <sub>PHL</sub>		(Note 1)	$C_L = 5 \text{ pF},$ See Fig. 11.1	3.3 ± 0.3		0.25		ns
Turn-ON time	t <sub>on</sub>	Control to Output		$R_L = 50 \Omega, C_L = 5 pF,$ See Fig. 11.2				1	μS
Turn-OFF time	t <sub>off</sub>			$R_L = 50 \Omega, C_L = 5 pF,$ See Fig. 11.2				1	
Break before Make	TBBM			$R_L = 50 \Omega, C_L = 5 pF,$ See Fig. 11.3		2.0	_	15	ns

Note 1: Parameter guaranteed by design.

# 10.3. Analog Switch (Note) (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Pin Name	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
OFF isolation (non-adjacent)	OIRR	D+, D-		$R_T = 50 \Omega$ , f = 240 MHz, See Fig. 11.4	3.3 ± 0.3	_	-27		dB
		R, L		$R_T = 50 \Omega$ , $f = 20 \text{ kHz}$ , See Fig. 11.4		_	-72	-	
Crosstalk (non-adjacent)	X <sub>talk</sub>	D+, D-		$R_T = 50 \Omega$ , f = 240 MHz, See Fig. 11.5		_	-36	-	dB
		R, L		$R_T = 50 \Omega$ , $f = 20 \text{ kHz}$ , See Fig. 11.5		_	-84	-	
-3dB Bandwidth	BW	D+, D-		$R_T = 50 \Omega$ , $C_L = 0 pF$ , See Fig. 11.6		_	720		MHz
Total harmonic distortion	THD	R, L		$V_{IN}$ = 2 $V_{p-p}$ , $R_L$ = 1 $k\Omega$ , f = 1 $kHz$		_	0.1		%

Note: Parameter guaranteed by design.

# 10.4. Capacitive Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Pin Name	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	$V_{BUS}$	(Note 1)	V <sub>IN</sub> = 0 V	3.3	20	pF
		Head, Man				5	
Switch terminal OFF-	C <sub>I/O</sub>	D+, D-		V <sub>I/O</sub> = 0 V, V <sub>BUS</sub> = GND or Open		3	
capacitance		R, L		V <sub>I/O</sub> = 0 V, Head = V <sub>CC</sub>		3.5	
		TX, RX		V <sub>I/O</sub> = 0 V, Man = V <sub>CC</sub>		5	
		COM+, COM-		$V_{I/O}$ = 0 V, $V_{BUS}$ = GND or Open, Head = $V_{CC}$ , Man = $V_{CC}$		4.5	
Switch terminal ON-	C <sub>I/O</sub>	D+, D-		V <sub>I/O</sub> = 0 V, V <sub>BUS</sub> = 4.25 V		8	
capacitance		R, L		$V_{I/O}$ = 0 V, $V_{BUS}$ = GND or Open, Head = GND		8.5	
		TX, RX		$V_{I/O}$ = 0 V, $V_{BUS}$ = GND or Open, Head = $V_{CC}$ , Man = GND		7.5	

Note 1: Parameter guaranteed by design.



### 11. AC Test Circuits and Waveforms

(D+, D-)

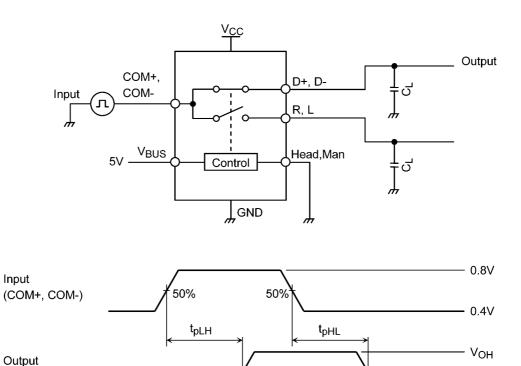


Fig. 11.1 Propagation Delay Time (tpLH, tpHL)

50%

50%

· V<sub>OL</sub>

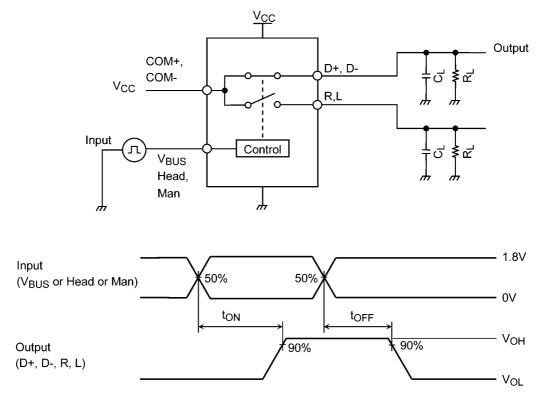


Fig. 11.2 Turn-ON and Turn-OFF Times (ton, toff)

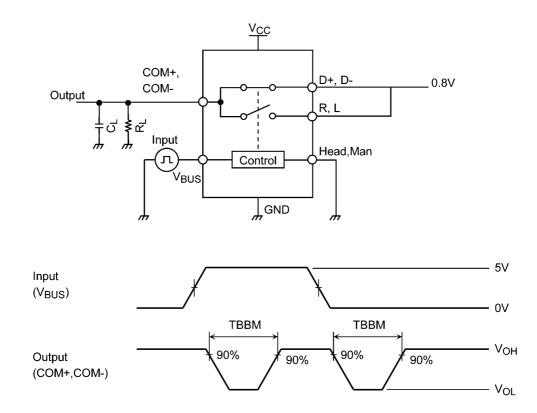


Fig. 11.3 Break Before Make (TBBM)

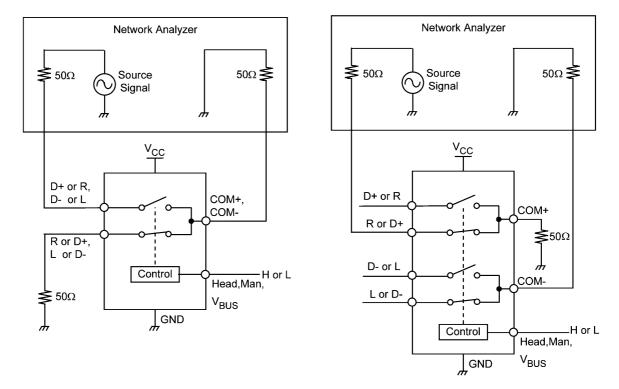


Fig. 11.4 OFF Isolation

Fig. 11.5 Crosstalk

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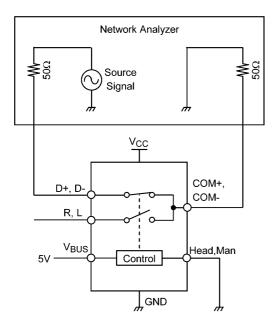
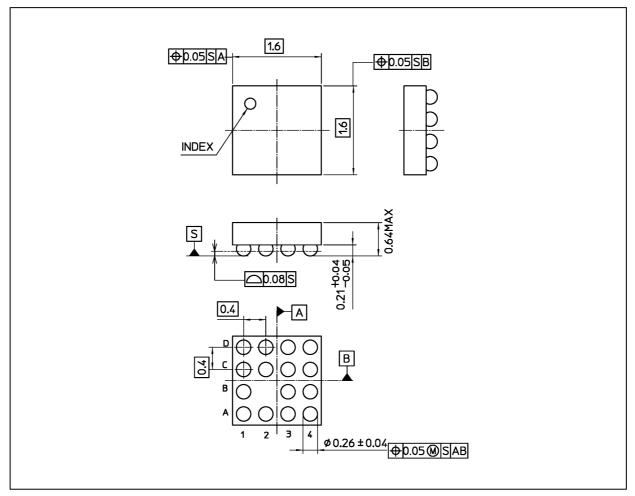


Fig. 11.6 -3dB Bandwidth



# **Package Dimensions**

Unit: mm



This resins used in this product include no flame retardants.

Weight: 0.003 g (typ.)

Package Name(s)
TOSHIBA: S-UFBGA15-0202-0.40A01
Nickname: WCSP15



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